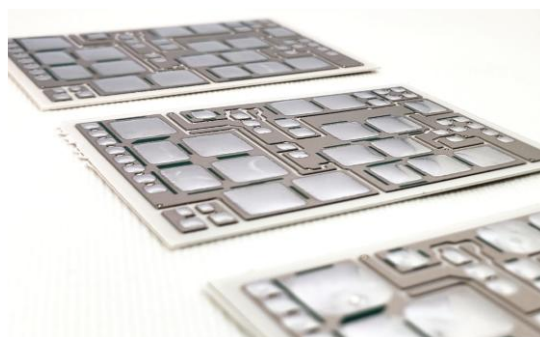


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MICRONOX Chemistries to Be KYZEN-Featured Products at IMAPS Symposium 2026

NASHVILLE — September 2026 — KYZEN, the global leader in innovative environmentally responsible cleaning chemistries, is pleased to announce its participation at the International Symposium on Microelectronics or IMAPS Symposium, taking place September 28-October 1 at the Encore Boston Harbor in Everett, MA. Attendees are invited to visit Booth 426 to connect with KYZEN's Scott Cain and learn more about KYZEN's innovative [MICRONOX](#) cleaning solutions engineered for today's most advanced and sensitive semiconductor applications.

With more than 35 years of expertise in high-reliability cleaning processes, KYZEN will showcase three industry-leading cleaning chemistries: the award-winning MICRONOX MX2123, organic acid residue cleaning agent MICRONOX MX2708, and IGBT Module Cleaner MICRONOX MX2127. Each formula is engineered to address specific contamination challenges requiring effective cleaning performance while preserving sensitive metals and maintaining process efficiency.



[MICRONOX® MX2123](#) is a balanced, multi-phase chemistry designed to remove flux residues from a wide range of IGBT module devices that utilize combinations of copper, silver and nickel DBC as substrates. MX2123 can remove slight metal oxidation from base metals for post wire bond and potting processes, leaving exceptional surface conditions after cleaning. It is effective at low temperatures, in low concentrations, and is easily monitored in in-line SIA or Ultrasonic Immersion cleaning systems.

[MICRONOX® MX2708](#) addresses the cleaning challenges associated with advanced leadless packaging, including Cu pillar flip chips, 2.5D/3D ICs, SiPs, and AiPs. Formulated to penetrate low standoff gaps and clean fine-pitch features, MX2708 effectively removes a wide range of organic acid flux residues at low, safe concentrations. It is non-corrosive to exposed metals and intermetallic alloys and is best suited for spray-in-air cleaning environments.

[MICRONOX® MX2127](#) is an aqueous, single-phase chemistry optimized for cleaning lead-free solder flux residues from IGBT modules built on copper and nickel DBC substrates. This chemistry leaves behind immaculate surface conditions, suitable for post-process steps like wire bonding and potting. MX2127 is designed for use in in-line spray-in-air (SIA) cleaning systems and offers an extended bath life, minimizing chemical consumption and improving overall process cost-efficiency.

For more than 35 years, KYZEN has developed award-winning cleaning solutions that balance performance, process compatibility, and environmental responsibility. The MICRONOX product line is trusted by semiconductor manufacturers worldwide to deliver consistent cleaning results, even on the most challenging assemblies. Visit **KYZEN at Booth 426** to learn how these advanced cleaning chemistries can enhance your production line and improve yield and end-product reliability.

For more information regarding these products and the full line of [MICRONOX products](https://www.kyzen.com/micronox-products), visit www.kyzen.com.

About KYZEN

KYZEN is a global leader in providing environmentally responsible, RoHS compliant precision cleaning chemistries for industries ranging from electronics and advanced packaging to metal finishing and aerospace applications. Since its founding in 1990, KYZEN's innovative cleaning technologies, scientific expertise and customer support have been repeatedly recognized with the industry's most prestigious awards. For more information, visit www.kyzen.com.